### PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
Maxim S. Shatalov	06/16/2011
Remigijus Gaska	06/16/2011
Jinwei Yang	06/16/2011
Michael Shur	06/22/2011

#### RECEIVING PARTY DATA

Name:	Sensor Electronic Technology, Inc.
Street Address:	1195 Atlas Road
City:	Columbia
State/Country:	SOUTH CAROLINA
Postal Code:	29209

# PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13162908

# CORRESPONDENCE DATA

Fax Number: (518)449-0047

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

518-449-0044 Phone:

Email: drubbone@hoffmanwarnick.com

Correspondent Name: Hoffman Warnick LLC Address Line 1: 75 State Street Address Line 2: 14th Floor

Address Line 4: Albany, NEW YORK 12207

ATTORNEY DOCKET NUMBER:	SETI-0057-CIP
NAME OF SUBMITTER:	John W. LaBatt

### Total Attachments: 4

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**PATENT REEL: 026513 FRAME: 0408** 

#### ASSIGNMENT OF PATENT APPLICATION

### FOR GOOD AND VALUABLE CONSIDERATION,

We, the undersigned (each) have agreed and hereby agree to assign for good and valuable consideration, receipt of which is hereby expressly acknowledged, and do hereby sell, assign and transfer unto

### Sensor Electronic Technology, Inc.

a corporation organized under the laws of the state of New York as Assignee, and its successors, assigns and legal representatives, the entire right, title and interest, for all countries in and to certain inventions relating to

# Semiconductor Material Doping

described in an application for Letters Patent of the United States, identified as Attorney Docket No. <u>SETI-0057-CIP</u>, at Hoffman Warnick LLC, 75 State Street, 14th Floor, Albany, NY 12207, and the invention(s) and improvement(s) set forth therein, and any and all continuations, continuations-in-part, divisionals, and renewals of and substitutes for either or both of the applications for said Letters Patent, and all the rights and privileges under any and all Letters Patent that may be granted therefor in any country, and any reissues, or reexaminations, or extensions of said Letters Patent. We request that any and all Letters Patent for said inventions be issued to said Assignee, its successors, assigns and legal representatives, or to such nominees as it may designate.

We agree that, when requested, we will, without charge to said Assignee but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable or convenient for securing and maintaining patents for said inventions in any and all countries and for vesting title thereto in said Assignee, its successors, assigns and legal representatives or nominees.

We authorize and empower the Assignee, its successors, assigns and legal representatives or nominees, to invoke and claim for any application for patent or other form of protection for said inventions filed by it or them, the benefit of the right of priority provided by the International Convention for the Protection of Industrial Property, as amended, or by any convention which may henceforth be substituted for it, and to invoke and claim such right of priority without further written or oral authorization from us.

We hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any assignment, consent to file or like document which may be required in any country for any purpose and more particularly in proof of the right of the Assignee or nominee to claim the aforesaid benefit of the right of priority provided by the International convention which may henceforth be substituted for it.

Page 1 of 2

We covenant with the Assignee, its successors, assigns and legal representatives, that the rights and property herein conveyed are free and clear of any encumbrance, and that we have full right to convey the same as herein expressed.

IN WITNESS WHEREOF, we have hereunto signed our name(s) on the day and year set forth below.

Inventor (signature)	06/16/11 DATE
Maxim S. Shatalov (Inventor's Typed Name)	
Inventor (signature)	<u>06-16-2011</u> DATE
Remigijus Gaska (Inventor's Typed Name)	
Inventor (signature)	6/16/11 DATE
Jinwei Yang (Inventor's Typed Name)	
Inventor (signature)	DATE
Michael Shur	
(Inventor's Typed Name)	

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Remigijus Gaska (Inventor's Typed Name)	<u></u>	
Inventor (signature)	DATE	<del></del>
Jinwei Yang (Inventor's Typed Name)	-	
Inventor (signature)	06/22/11 DATE	
Michael Shur	_	
(Inventor's Typed Name)		

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